



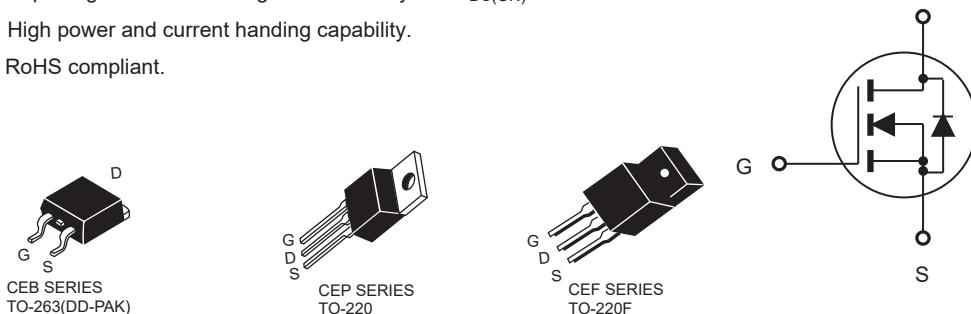
CEP07N65SA/CEB07N65SA CEF07N65SA

N-Channel Enhancement Mode Field Effect Transistor

FEATURES

Type	V_{DSS}	$R_{DS(ON)}$	I_D	@ V_{GS}
CEP07N65SA	650V	0.65Ω	7A	10V
CEB07N65SA	650V	0.65Ω	7A	10V
CEF07N65SA	650V	0.65Ω	7A ^d	10V

- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handing capability.
- RoHS compliant.



ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit		Units
		TO-220/263	TO-220F	
Drain-Source Voltage	V_{DS}	650		V
Gate-Source Voltage	V_{GS}	± 30		V
Drain Current-Continuous @ $T_C = 25^\circ\text{C}$ @ $T_C = 100^\circ\text{C}$	I_D	7	7^d	A
		4.4	4.4^d	A
Drain Current-Pulsed ^a	I_{DM}^e	28	28^d	A
Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ - Derate above 25°C	P_D	78	34	W
		0.62	0.27	W/ $^\circ\text{C}$
Single Pulsed Avalanche Energy ^h	E_{AS}	120		mJ
Single Pulsed Avalanche Current ^h	I_{AS}	2		A
Operating and Store Temperature Range	T_J, T_{stg}	-55 to 150		$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Limit		Units
Thermal Resistance, Junction-to-Case	R_{JC}	1.6	3.7	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient	R_{JA}	62.5	65	$^\circ\text{C}/\text{W}$



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Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	650			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 650\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
Gate Body Leakage Current, Forward	I_{GSSF}	$V_{\text{GS}} = 30\text{V}, V_{\text{DS}} = 0\text{V}$			100	nA
Gate Body Leakage Current, Reverse	I_{GSSR}	$V_{\text{GS}} = -30\text{V}, V_{\text{DS}} = 0\text{V}$			-100	nA
On Characteristics^b						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = 250\mu\text{A}$	2.5		4.5	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 5\text{A}$		0.55	0.65	Ω
Dynamic Characteristics^c						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 150\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		485		pF
Output Capacitance	C_{oss}			55		pF
Reverse Transfer Capacitance	C_{rss}			20		pF
Switching Characteristics^c						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 300\text{V}, I_D = 3.5\text{A}, V_{\text{GS}} = 15\text{V}, R_{\text{GEN}} = 10\Omega$		20		ns
Turn-On Rise Time	t_r			7		ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			41		ns
Turn-Off Fall Time	t_f			10		ns
Total Gate Charge	Q_g	$V_{\text{DS}} = 480\text{V}, I_D = 3.5\text{A}, V_{\text{GS}} = 10\text{V}$		12		nC
Gate-Source Charge	Q_{gs}			2.2		nC
Gate-Drain Charge	Q_{gd}			5.3		nC
Drain-Source Diode Characteristics and Maximum Ratings						
Drain-Source Diode Forward Current	I_S ^f				7	A
Drain-Source Diode Forward Voltage ^b	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_S = 5\text{A}$ ^g			1.5	V
Reverse Recovery Time	T_{rr}	$I_F = 5\text{A}, dI/dt = 100\text{A}/\mu\text{s}$		244		ns
Reverse Recovery Charge	Q_{rr}			1.66		uC
Peak Reverse Recovery Current	I_{rr}			12		A
Notes :						
a.Repetitive Rating : Pulse width limited by maximum junction temperature .						
b.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.						
c.Guaranteed by design, not subject to production testing.						
d.Limited only by maximum temperature allowed .						
e.Pulse width limited by safe operating area .						
f.Full package $I_{\text{S}(\text{max})} = 4.6\text{A}$.						
g.Full package V_{SD} , test condition $I_S = 4.6\text{A}$.						
h. $L = 60\text{mH}, I_{\text{AS}} = 2\text{A}, V_{\text{DD}} = 50\text{V}, R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$.						



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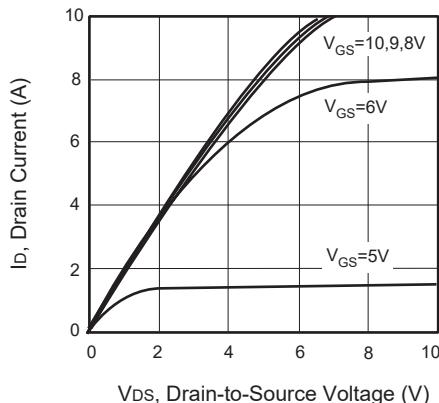


Figure 1. Output Characteristics

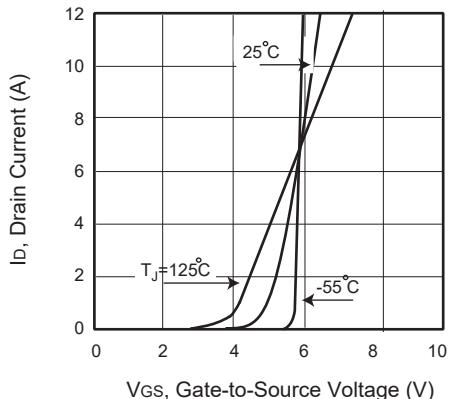


Figure 2. Transfer Characteristics

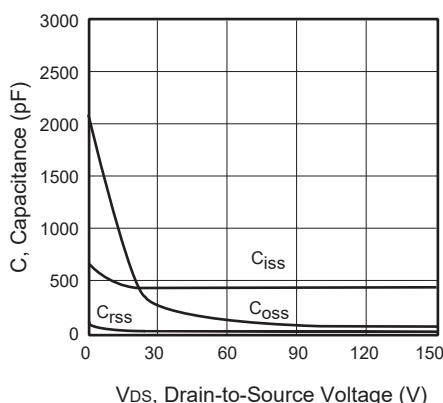


Figure 3. Capacitance

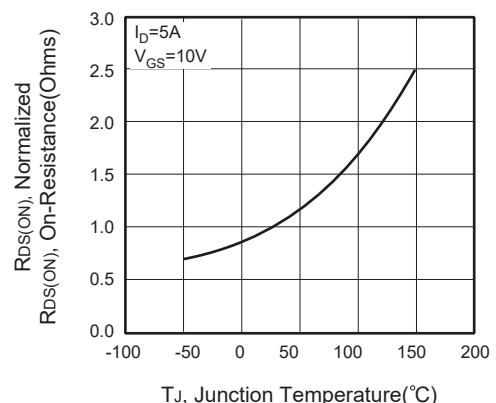


Figure 4. On-Resistance Variation with Temperature

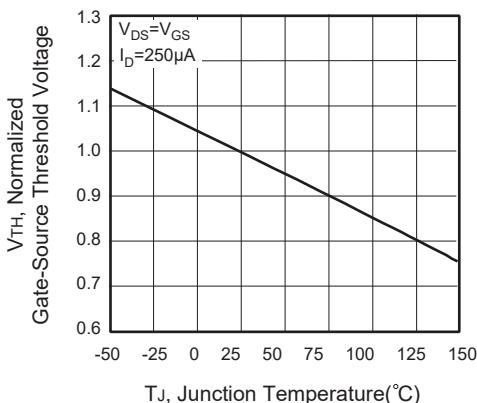


Figure 5. Gate Threshold Variation with Temperature

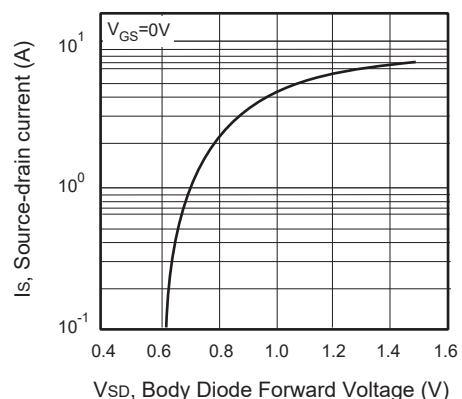


Figure 6. Body Diode Forward Voltage Variation with Source Current



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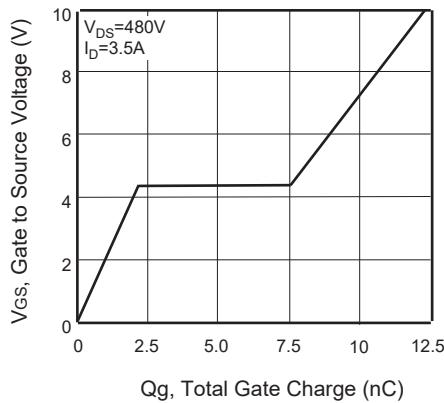


Figure 7. Gate Charge

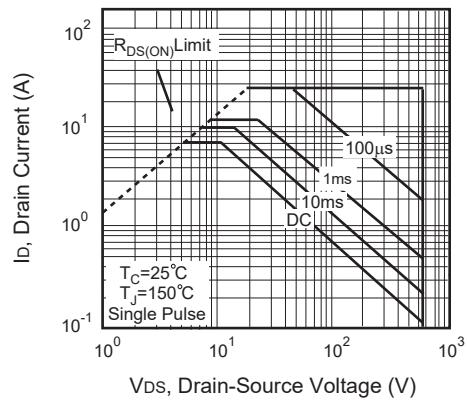


Figure 8. Maximum Safe
Operating Area

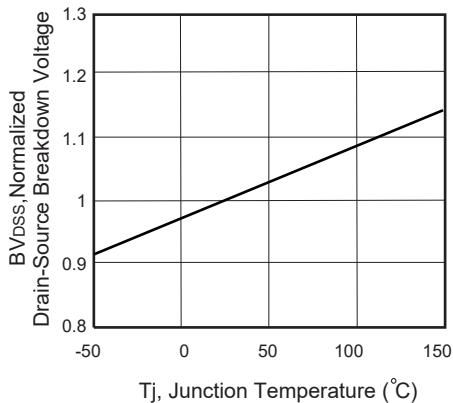


Figure 9. Breakdown Voltage Variation
VS Temperature

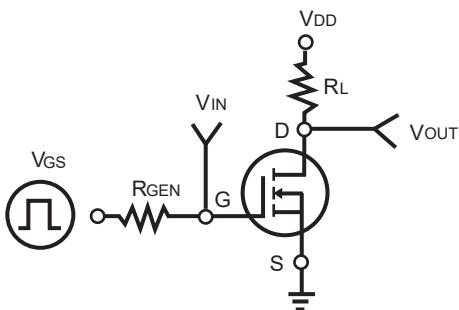


Figure 10. Switching Test Circuit

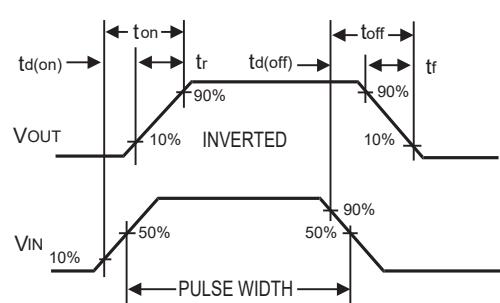


Figure 11. Switching Waveforms



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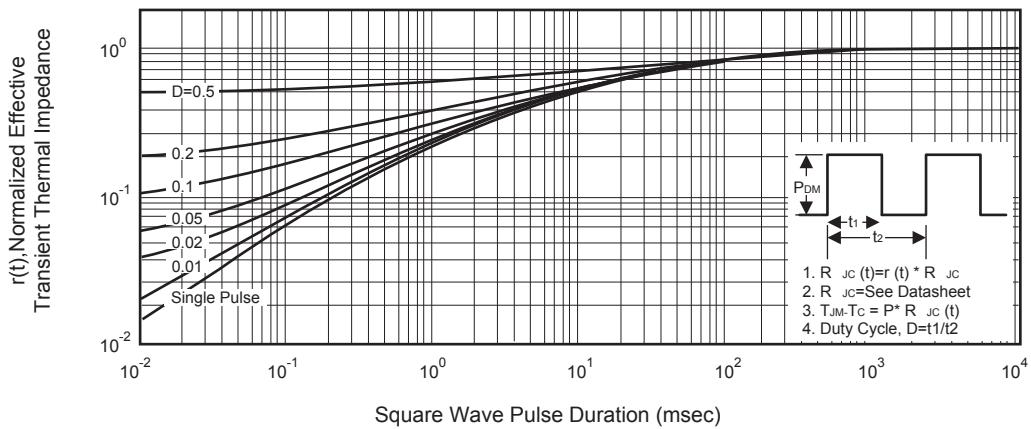


Figure 12. Normalized Thermal Transient Impedance Curve